ON Semiconductor®



# Praetorian ® C-L-C LCD and Camera EMI FilterArray with ESD Protection

CM1460

#### **Features**

- Four, six, and eight channels of EMI filtering with integrated ESD protection
- Pi-style EMI filters in a capacitor-inductorcapacitor (C-L-C) network
- ±15kV ESD protection on each channel (IEC 61000-4-2 Level 4, contact discharge)
- ±30kV ESD protection on each channel (HBM)
- Greater than -35dB attenuation (typical) at 1GHz
- TDFN lead-free package with 0.50mm lead pitch:
  - 4-ch. = 8-lead TDFN
  - 6-ch. = 12-lead TDFN
  - 8-ch. = 16-lead TDFN
- Tiny TDFN package size:
  - 8-lead: 2.00mm x 2.00mm
  - 12-lead: 3.00mm x 1.35mm
  - 16-lead: 4.00mm x 1.60mm
- Increased robustness against vertical impacts during manufacturing process
- · Lead-free RoHS compliant finishing

### **Applications**

- LCD and camera data lines in mobile handsets.
- I/O port protection for mobile handsets, notebook computers, PDAs etc.
- EMI filtering for data ports in cell phones, PDAs or notebook computers.
- Wireless handsets
- Handheld PCs/PDAs
- · LCD and camera modules

#### **Product Description**

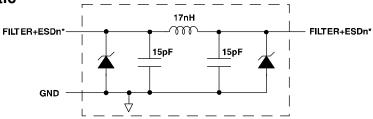
The CM1460 is a family of pi-style EMI filter arrays with ESD protection, which integrates four, six and eight filters (C-L-C) in small form factor TDFN 0.50mm pitch packages. Each EMI filter channel of the CM1460 is implemented as a 3-pole L-C filter where the component values are 15pF-17nH-15pF. The CM1460's roll-off frequency at -6dB attenuation is 350MHz and can be used in applications where the data rates are as high as 140Mbps while providing greater than 30dB over the 800MHz to 2.7GHz frequency range.

The parts include ESD diodes on every pin, which provide a very high level of protection for sensitive electronic components that may be subjected to electrostatic discharge (ESD). The ESD protection diodes connected to the filter ports are designed and characterized to safely dissipate ESD strikes of  $\pm 15 \mathrm{kV}$ , beyond the maximum requirement of the IEC61000-4-2 international standard. Using the MIL-STD-883 (Method 3015) specification for Human Body Model (HBM) ESD, the pins are protected for contact discharges at greater than  $\pm 30 \mathrm{kV}$ .

This device is particularly well suited for wireless handsets, mobile LCD modules and PDAs because of its small package format and easy-to-use pin assignments. In particular, the CM1460 is ideal for EMI filtering and protecting data and control lines for the LCD display and camera interface in mobile handsets.

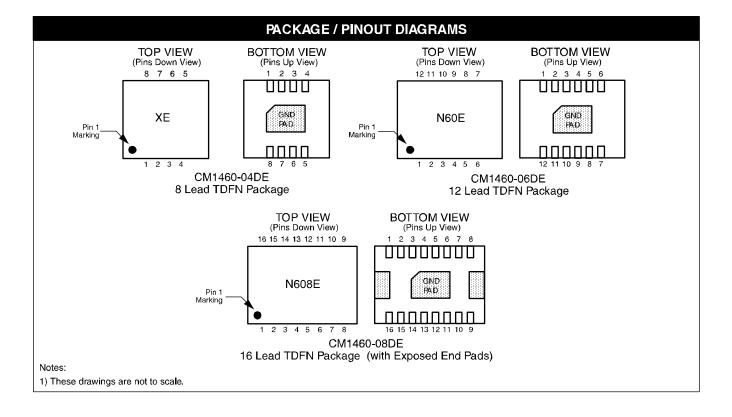
The CM1460 is housed in space saving, low profile, 0.50mm pitch TDFN packages and is available in lead-free format.

#### **Electrical Schematic**



\* See P ackage/Pinout Dia gram for expanded pin information.

1 of 4, 6 or 8 EMI/RFI Filter Channels with Integrated ESD Protection



PIN DESCRIPTIONS										
DEVICE PIN(s)					DEVICE PIN(s)					
-04	-06	-08	NAME	DESCRIPTION		-04 -06 -08		NAME	DESCRIPTION	
1	1	1	FILTER1	Filter + ESD Channel 1		8	12	16	FILTER1	Filter + ESD Channel 1
2	2	2	FILTER2	Filter + ESD Channel 2		7	11	15	FILTER2	Filter + ESD Channel 2
3	3	3	FILTER3	Filter + ESD Channel 3		6	10	14	FILTER3	Filter + ESD Channel 3
4	4	4	FILTER4	Filter + ESD Channel 4		5	9	13	FILTER4	Filter + ESD Channel 4
	5	5	FILTER5	Filter + ESD Channel 5	+ ESD Channel 5 8 12		12	FILTER5	Filter + ESD Channel 5	
	6	6	6 FILTER6 Filter + ESD Channel 6				7	11	FILTER6	Filter + ESD Channel 6
		7	FILTER7	Filter + ESD Channel 7				10	FILTER7	Filter + ESD Channel 7
		8	FILTER8	Filter + ESD Channel 8				9	FILTER8	Filter + ESD Channel 8
GND PAD		GND	Device Ground							

# **Ordering Information**

PART NUMBERING INFORMATION								
Pins	Pins Package Ordering Part Number <sup>1</sup> Part Mark							
8	TDFN-8	CM1460-04DE	XE					
12	TDFN-12	CM1460-06DE	N60E					
16	TDFN-16 EEP	CM1460-08DE	N608E					

Note 1: Parts are shipped in Tape & Reel form unless otherwise specified.

CM1460

# **Specifications**

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	RATING	UNITS				
Storage Temperature Range	-65 to +150	℃				
Current per Inductor	30	mA				
DC Package Power Rating	500	mW				

STANDARD OPERATING CONDITIONS						
PARAMETER	RATING	UNITS				
Operating Temperature Range	-40 to +85	∞				

#### ELECTRICAL OPERATING CHARACTERISTICS (SEE NOTE1) **SYMBOL PARAMETER** CONDITIONS MIN **TYP** MAX **UNITS** L 17 Channel Inductance nΗ $\mathbf{C}_{\text{total}}$ **Total Channel Capacitance** At 2.5VDC Reverse 24 30 36 рF Bias, 1MHz, 30mVAC С рF Capacitance C1 At 2.5VDC Reverse 15 Bias, 1MHz, 30mVAC $\boldsymbol{V}_{\text{DIODE}}$ ٧ Standoff Voltage 6.0 $I_{DIODE} = 10 \mu A$ Diode Leakage Current (reverse bias) $V_{DIODE} = +3.3V$ 0.1 1.0 μΑ $I_{\text{LEAK}}$ $V_{SIG}$ Signal Clamp Voltage Positive Clamp $I_{LOAD} = 10mA$ 5.6 6.8 9.0 V $I_{LOAD} = -10 \text{mA}$ **Negative Clamp** -1.5-0.8-0.4 ٧ $V_{\rm ESD}$ In-system ESD Withstand Voltage Notes 2 and 3 a) Human Body Model, MIL-STD-883, Method ±30 k۷ b) Contact Discharge per IEC 61000-4-2 Level 4 k۷ ±15 $R_{\scriptscriptstyle DYN}$ Dynamic Resistance Positive 2.3 Ω Negative 0.9 Ω Roll-off Frequency at -6dB Attenuation $f_{_{\rm R}}$ 350 MHz $Z_{\text{SOURCE}} = 50\Omega, Z_{\text{LOAD}} = 50\Omega$

Note 1:  $T_A=25$  °C unless otherwise specified.

Note 2: ESD applied to input and output pins with respect to GND, one at a time.

Note 3: Clamping voltage is measured at the opposite side of the EMI filter to the ESD pin (i.e. if ESD is applied to pin A1 then clamping voltage is measured at pin C1). Unused pins are left open.

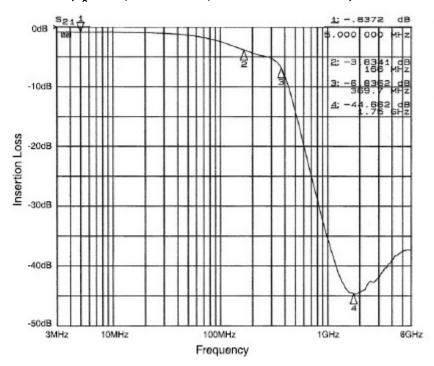


Figure 1. Filter 1 Insertion Loss (CM1460-04DE)

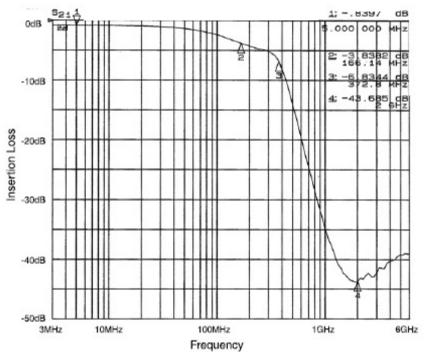


Figure 2. Filter 2 Insertion Loss (CM1460-04DE)

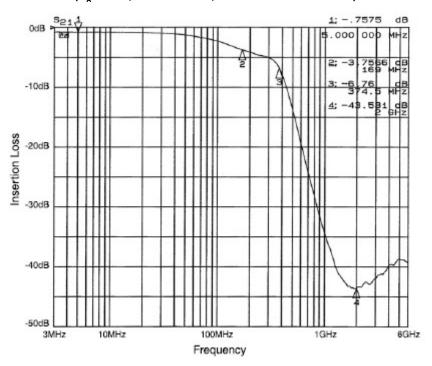


Figure 3. Filter 3 Insertion Loss (CM1460-04DE)

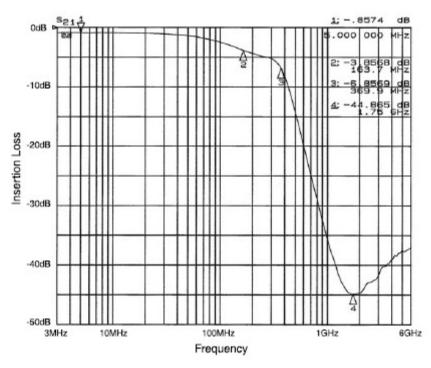


Figure 4. Filter 4 Insertion Loss (CM1460-04DE)

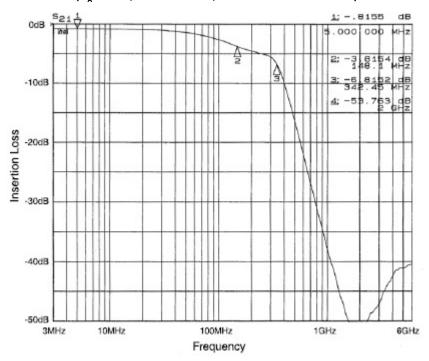


Figure 5. Filter 1 Insertion Loss (CM1460-06DE)

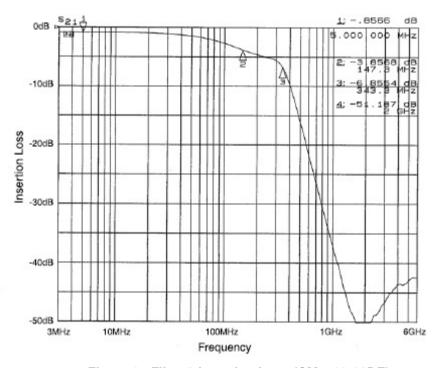


Figure 6. Filter 2 Insertion Loss (CM1460-06DE)

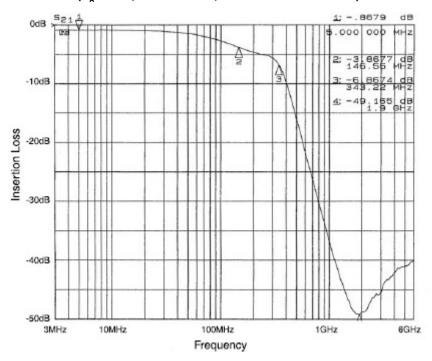


Figure 7. Filter 3 Insertion Loss (CM1460-06DE)

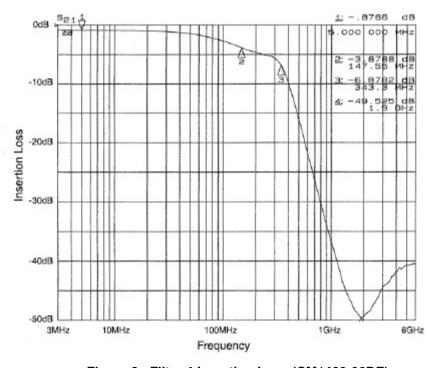


Figure 8. Filter 4 Insertion Loss (CM1460-06DE)

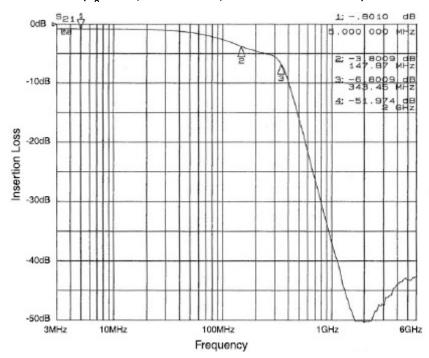


Figure 9. Filter 5 Insertion Loss (CM1460-06DE)

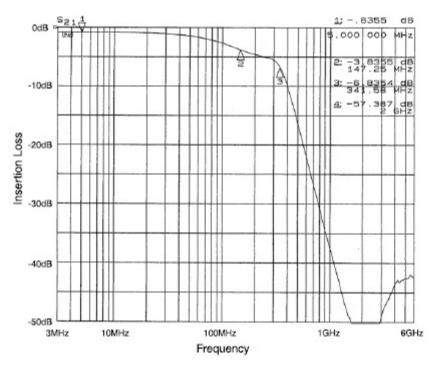


Figure 10. Filter 6 Insertion Loss (CM1460-06DE)

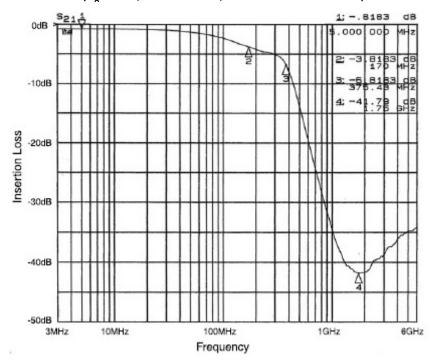


Figure 11. Filter 1 Insertion Loss (CM1460-08DE)

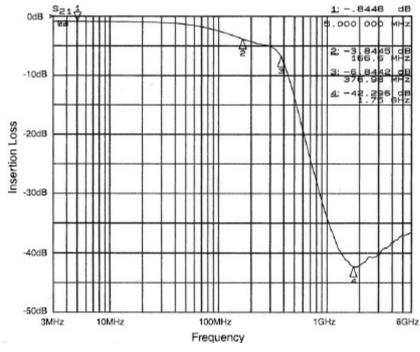


Figure 12. Filter 2 Insertion Loss (CM1460-08DE)

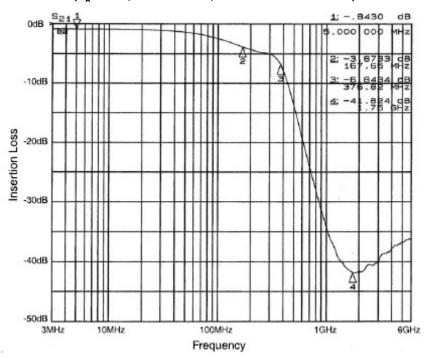


Figure 13. Filter 3 Insertion Loss (CM1460-08DE)

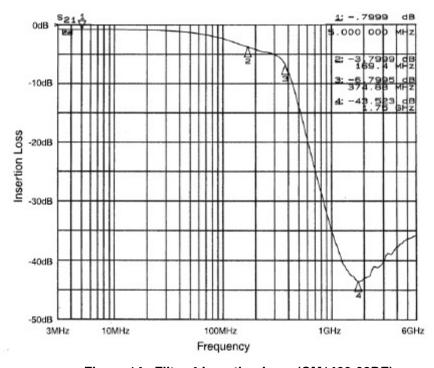


Figure 14. Filter 4 Insertion Loss (CM1460-08DE)

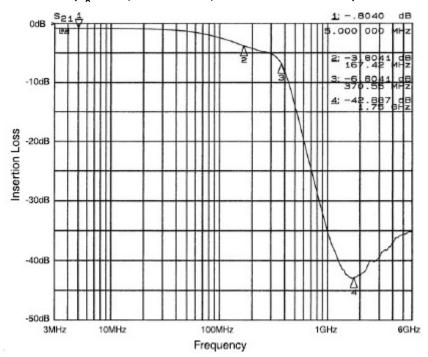


Figure 15. Filter 5 Insertion Loss (CM1460-08DE)

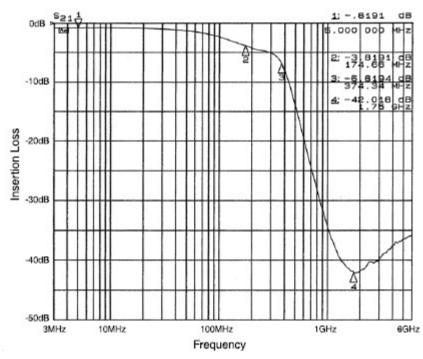


Figure 16. Filter 6 Insertion Loss (CM1460-08DE)

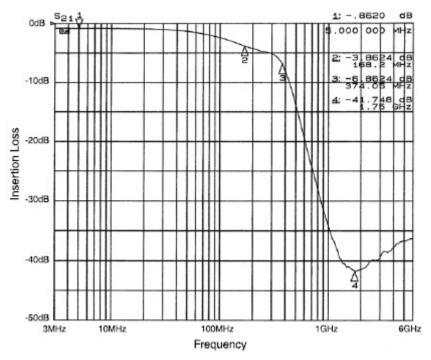


Figure 17. Filter 7 Insertion Loss (CM1460-08DE)

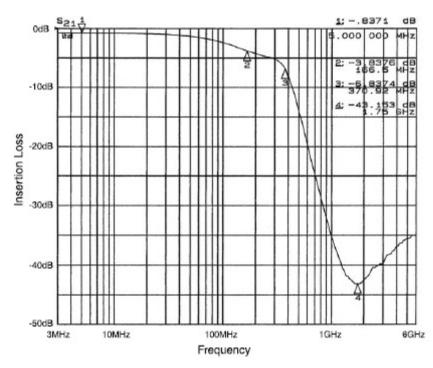


Figure 18. Filter 8 Insertion Loss (CM1460-08DE)

#### Typical Diode Capacitance vs. Input Voltage

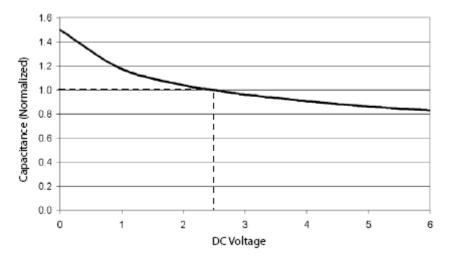


Figure 19. Filter Capacitance vs. Input Voltage (normalized to capacitance at 2.5VDC and 25  $^{\circ}$ C)

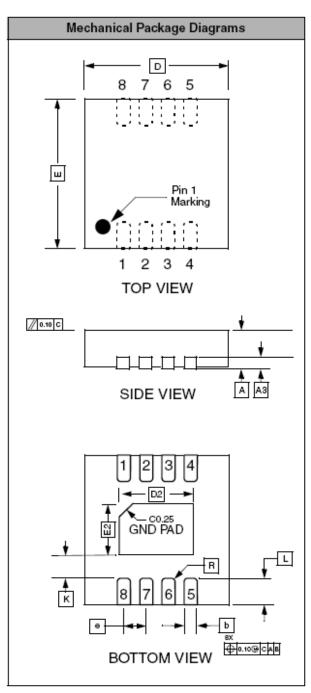
#### **Mechanical Details**

#### **TDFN-08 Mechanical Specifications, 0.5mm**

The CM1460-04DE is supplied in an 8-lead 0.5mm TDFN package. Dimensions are presented below.

PACKAGE DIMENSIONS									
Package	TDFN								
JEDEC No.	MO-229 (Var. VCCD-3)*								
Leads				8					
Dim.	N	lillimete	rs	Inches					
Diiii.	Min	Nom	Max	Min	Nom	Max			
Α	0.70	0.75	0.80	0.028	0.030	0.031			
А3	(	0.20 RE	F	0.008 REF					
b	0.20	0.20 0.25		0.008	0.010	0.012			
D	1.90	2.00	2.10	0.075	0.079	0.083			
D2	1.50	1.60	1.70	0.059	0.063	0.067			
E	1.90	2.00	2.10	0.075	0.079	0.083			
E2	0.80	0.90	1.00	0.031	0.035	0.039			
е	0.50 BSC 0.020 BSC								
К	0.20			0.008					
L	0.20	0.30	0.40	0.008	0.012	0.016			
# per tape and reel				pieces					
	Contro	olling din	nension:	millimet	ters				

<sup>\*</sup>This package is compliant with JEDEC standard MO-229, variation VCCD-3 with exception of the D2 and E2 dimensions as called out in the table above and the r1 dimension which is not specified in the MO-229 standard.



Dimensions for 8-Lead, 0.5mm pitch TDFN package

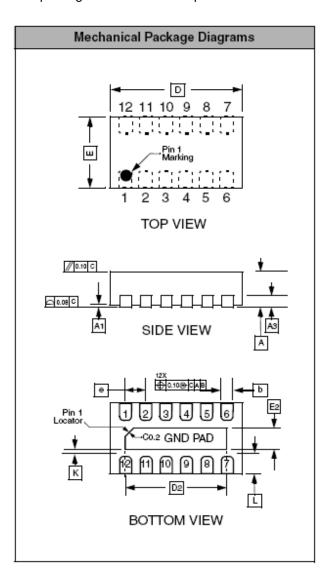
## Mechanical Details (Cont'd)

#### **TDFN-12 Mechanical Specifications, 0.5mm**

The CM1460-06DE is supplied in an 12-lead, 0.5mm pitch TDFN package. Dimensions are presented below.

PACKAGE DIMENSIONS									
Package	TDFN								
JEDEC No.	MO-229C*								
Leads			1	2					
Dim.	N	lillimete	rs	Inches					
Diiii.	Min	Nom	Max	Min	Nom	Max			
Α	0.70	0.75	0.80	0.028	0.030	0.031			
A1	0.00	0.02	0.05	0.000	0.001	0.002			
А3	0.20 REF			0.008 REF					
b	0.20	0.25	0.30	0.008	0.010	0.012			
D	2.90	3.00	3.10	0.114	0.118	0.122			
D2	2.40	2.50	2.60	0.095	0.098	0.102			
E	1.25	1.35	1.45	0.049	0.053	0.057			
E2	0.30	0.40	0.50	0.012	0.016	0.020			
е	0.50 BSC 0.020 BSC					SC			
К	0.20			0.008					
L	0.20	0.25	0.30	0.008	0.010	0.012			
# per tape and reel	3000 pieces								
Controlling dimension: millimeters									

<sup>\*</sup>This package is compliant with JEDEC standard MO-229C with the exception of the D, D2, E, E2, K and L dimensions as called out in the table above.



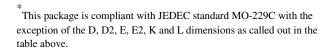
Dimensions for 12-Lead, 0.5mm pitch TDFN package

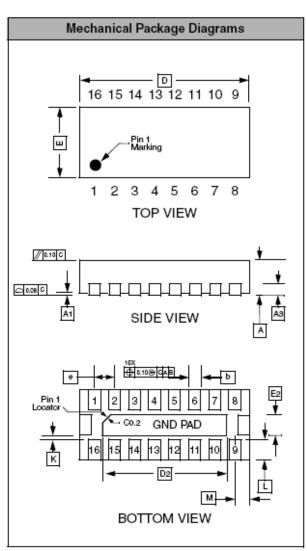
#### **Mechanical Details (Cont'd)**

#### **TDFN-16EEP Mechanical Specifications, 0.5mm**

The CM1460-08DE is supplied in a 16-lead, 0.5mm pitch TDFN package with Exposed End Pads (EEP). Dimension are presented below.

PACKAGE DIMENSIONS									
Package	TDFN								
JEDEC No.	MO-229C*								
Leads			1	16					
Dim.	N	lillimete	rs	Inches					
Dilli.	Min	Nom	Max	Min	Nom	Max			
Α	0.70	0.75	0.80	0.028	0.030	0.031			
<b>A</b> 1	0.00	0.02	0.05	0.000	0.001	0.002			
А3	(	0.20 RE	F	0.008 REF					
b	0.20 0.25 0.3		0.30	0.008	0.010	0.012			
D	3.90	4.00	4.10	0.153	0.157	0.161			
D2	3.10	3.20	3.30	0.122	0.126	0.130			
E	1.50	1.60	1.70	0.059	0.063	0.067			
E2	0.30	0.40	0.50	0.012	0.016	0.020			
е	(	0.50 BS	С	0.020 BSC					
К	0.20			0.008					
L	0.20	0.30	0.40	0.008	0.010	0.012			
М	0.25 REF 0.010 REF								
# per tape and reel	3000 pieces								
	Contro	olling din	nension:	millimet	ters				





Dimensions for 16-Lead, 0.5mm pitch TDFN package with Exposed End Pads (EEP)

#### CM1460

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